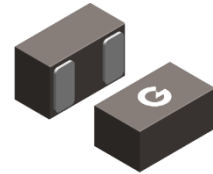
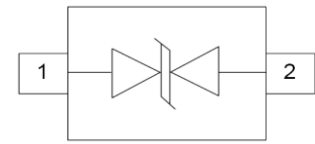


Features

- ESD / transient protection of high speed data lines
 - IEC 61000-4-2 (ESD): $\pm 30\text{kV}$ (air), $\pm 30\text{kV}$ (contact)
- Working voltage: $V_{RWM} = 5\text{V}$
- Very Low Leakage current
- Very low load capacitance
- RoHS compliant with Halogen-free

HF



DFN1006-2

Mechanical Data

- Case: DFN1006-2
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
ESDSSB5V0X1BL	DFN1006-2	10000 pcs / Tape & Reel	SBB

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

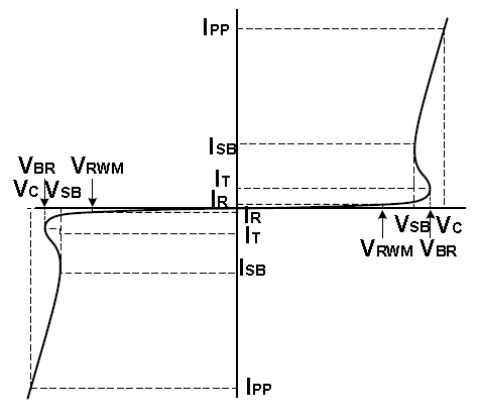
Parameter	Symbol	Value	Unit
IEC 61000-4-2; ESD (Air)	V_{ESD-A}	± 30	kV
IEC 61000-4-2; ESD (Contact)	V_{ESD-C}	± 30	kV
Peak Pulse Power ($t_p = 8/20\mu\text{s}$)	P_{PP}	60	W
Peak Pulse Current ($t_p = 8/20\mu\text{s}$)	I_{PP}	5	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	0.25	W
Thermal Resistance Junction-to-Air	$R_{\theta JA}$	400	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Lead	$R_{\theta JL}$	204	$^\circ\text{C/W}$
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	240	$^\circ\text{C/W}$
Junction Temperature	T_J	-55 ~ +125	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Electrical Parameters

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Reverse Stand-off Voltage
I_R	Reverse Leakage Current @ V_{RWM}
$V_{(BR)}$	Reverse Breakdown Voltage @ I_T
I_T	Test Current
V_{SB}	Snap-Back Voltage @ I_{SB}
I_{SB}	Snap-Back Current



The graph illustrates the reverse characteristic of the TVS diode. The vertical axis represents current (I) and the horizontal axis represents voltage (V). Key points on the curve include: V_{BR} (Reverse Breakdown Voltage) at current I_R ; V_{RWM} (Reverse Stand-off Voltage) at current I_R ; V_C (Clamping Voltage) at current I_{PP} ; V_{SB} (Snap-Back Voltage) at current I_{SB} ; and I_{PP} (Reverse Peak Pulse Current) at voltage V_C . The test current I_T is also indicated.

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Reverse Stand-off Voltage	V_{RWM}		-	-	5	V
Reverse Breakdown Voltage	$V_{(BR)}$	$I_T = 1\text{mA}$	5.8	-	9.5	V
Reverse Leakage Current	I_R	$V_{RWM} = 5\text{V}$	-	-	200	nA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}, t_p = 8/20\mu\text{s}$	-	6	8	V
		$I_{PP} = 5\text{A}, t_p = 8/20\mu\text{s}$	-	8.5	12	V
		$I_{PP} = 16\text{A}, t_p = 100\text{ns}$	-	11	-	V
Junction Capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$	-	0.3	0.4	pF

Ratings and Characteristic Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

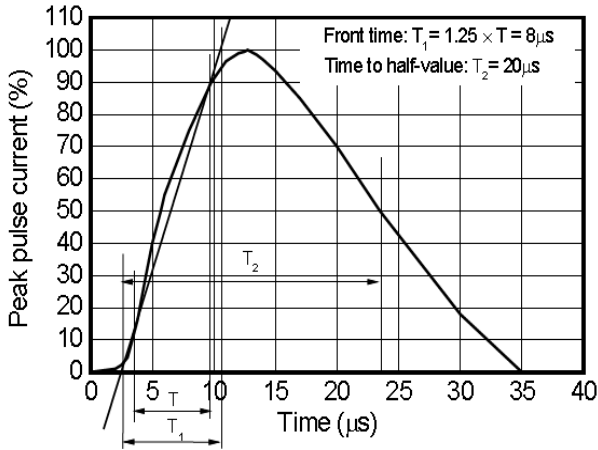


Fig 1 8/20 μs waveform per IEC61000-4-5

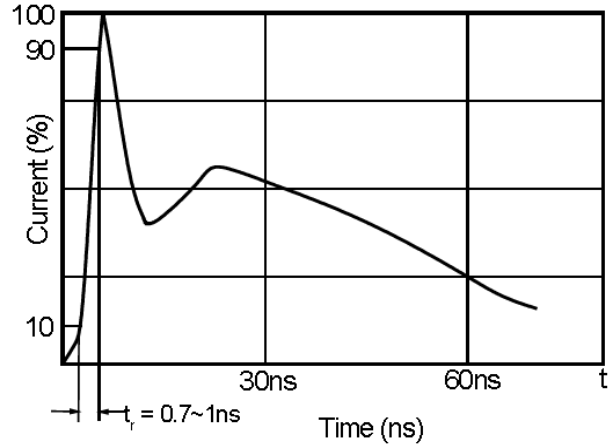


Fig 2 ESD pulse waveform according to IEC61000-4-2

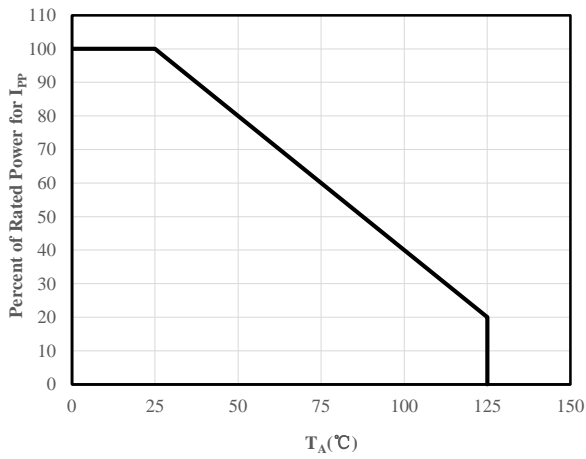


Fig 3 Power Derating Curve

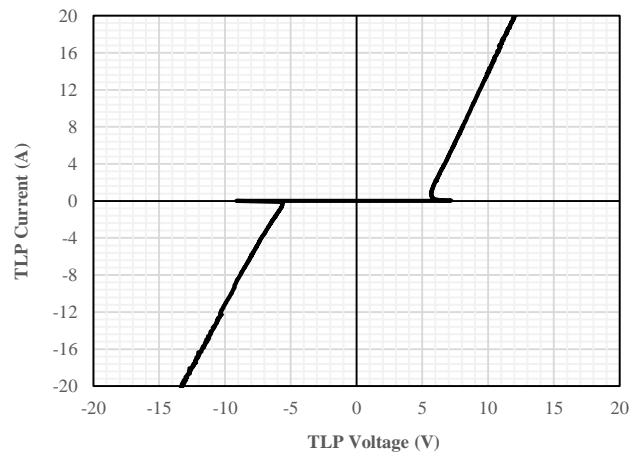
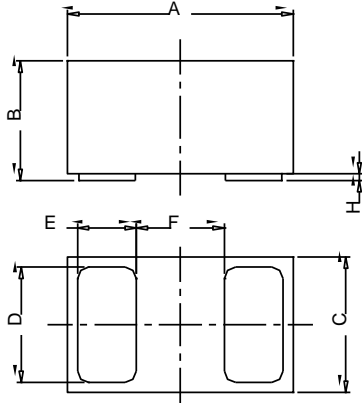


Fig 4 TLP Measurement

Package Outline Dimensions (Unit: mm)



DFN1006-2			
Dimension	Min.	Typ.	Max.
A	0.95	1.00	1.075
B	0.47	0.50	0.53
C	0.55	0.60	0.675
D	0.45	0.50	0.55
E	0.20	0.25	0.30
F	-	0.40	-
H	0	0.03	0.05

Package Outline Dimensions (Unit: mm)

DFN1006-2

